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SEMICONDUCTOR®

## FDT86256

# N-Channel PowerTrench<sup>®</sup> MOSFET 150 V, 1.2 A, 845 m $\Omega$

#### Features

- Max  $r_{DS(on)}$  = 845 m $\Omega$  at  $V_{GS}$  = 10 V,  $I_D$  = 1.2 A
- Max  $r_{DS(on)}$  = 1280 m $\Omega$  at  $V_{GS}$  = 6.0 V,  $I_D$  = 1.0 A
- Very low Qg and Qgd compared to competing trench technologies
- Fast switching speed
- 100% UIL Tested
- RoHS Compliant

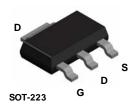


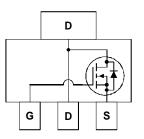
## **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that has been especially tailored to minimize the on-state resistance and switching loss. G-S zener has been added to enhance ESD voltage level.

### **Applications**

- DC-DC conversion
- Inverter
- Synchronous Rectifier





### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol		P	Ratings	Units		
V <sub>DS</sub>	Drain to	Source Voltage	150	V		
V <sub>GS</sub>	Gate to \$	Source Voltage	±20	V		
ID	Drain Cu	rrent -Continuous (Packa	3			
		-Continuous (Silicor	2.5	•		
		-Continuous	T <sub>A</sub> = 25	°C (Note 1a)	1.2	Α
		-Pulsed	2			
E <sub>AS</sub>	Single P	ulse Avalanche Energy		(Note 3)	1	mJ
P <sub>D</sub>	Power Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$				10	W
	Power D	issipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.3	vv
T <sub>J</sub> , T <sub>STG</sub>	Operatin	g and Storage Junction Te	-55 to +150	°C		
Thermal Ch		stics Resistance. Junction to Ca	250		12	
R <sub>0JC</sub>		,		°C/W		
$R_{\thetaJA}$	Inermai	Resistance, Junction to Ar	55			
Package M	arking aı	nd Ordering Informa	tion			
Device Marking		Device	Package	Reel Size	Tape Width	Quantity
86256		FDT86256	SOT-223	13 "	12 mm	2500 units

August 2011

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	150			V	
$\Delta BV_{DSS}$ $\Delta T_J$	Breakdown Voltage Temperature	$I_D = 250 \ \mu$ A, referenced to 25 °C		100		mV/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 120 V, V <sub>GS</sub> = 0 V			1	μA	
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μA	
On Chara	cteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2	3.5	4	V	
$\Delta V_{GS(th)}$ $\Delta T_J$	Gate to Source Threshold Voltage Temperature Coefficient	to Source Threshold Voltage $I_{D} = 250 \mu A$ referenced to 25 °C.		-8		mV/°C	
r <sub>DS(on)</sub>		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1.2 A		695	845		
	Static Drain to Source On Resistance	V <sub>GS</sub> = 6 V, I <sub>D</sub> = 1.0 A		912	2 1280 mΩ		
		$V_{GS} = 10 \text{ V}, \ \text{I}_{D} = 1.2 \text{ A}, \ \text{T}_{J} = 125 \ ^{\circ}\text{C}$		1298	1367		
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 1.2 A		0.3		S	
Dvnamic	Characteristics						
C <sub>iss</sub>	Input Capacitance			55	73	pF	
C <sub>oss</sub>	Output Capacitance	$V_{\rm DS} = 75  \text{V},  V_{\rm GS} = 0  \text{V},$		8	11	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1MHz		1	1.4	pF	
Rg	Gate Resistance			1.3		Ω	
Switching	Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time			2.7	10	ns	
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 75 V, I <sub>D</sub> = 1.2 A,		1.7	10	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		4.8	10	ns	
t <sub>f</sub>	Fall Time			2.6	10	ns	
Q <sub>g(TOT)</sub>	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		1.2	2.0	nC	
Q <sub>g(TOT)</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 6 V V_{DD} = 75 V,$		0.8	1.0		
$Q_{gs}$	Gate to Source Charge	I <sub>D</sub> = 1.2 A		0.4		nC	
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			0.3		nC	
0	urce Diode Characteristics						
V <sub>SD</sub>		$V_{GS} = 0 V, I_{S} = 1.2 A$ (Note 2)		0.9	1.3	V	
	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 1.0 A$ (Note 2)		0.8	1.3		
t <sub>rr</sub>	Reverse Recovery Time			47	75	ns	
Q <sub>rr</sub>	Reverse Recovery Charge	– I <sub>F</sub> = 1.2 A, di/dt = 100 A/μs		24	38	nC	

NOTES:

1. R<sub>0JA</sub> is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.



a) 55 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper

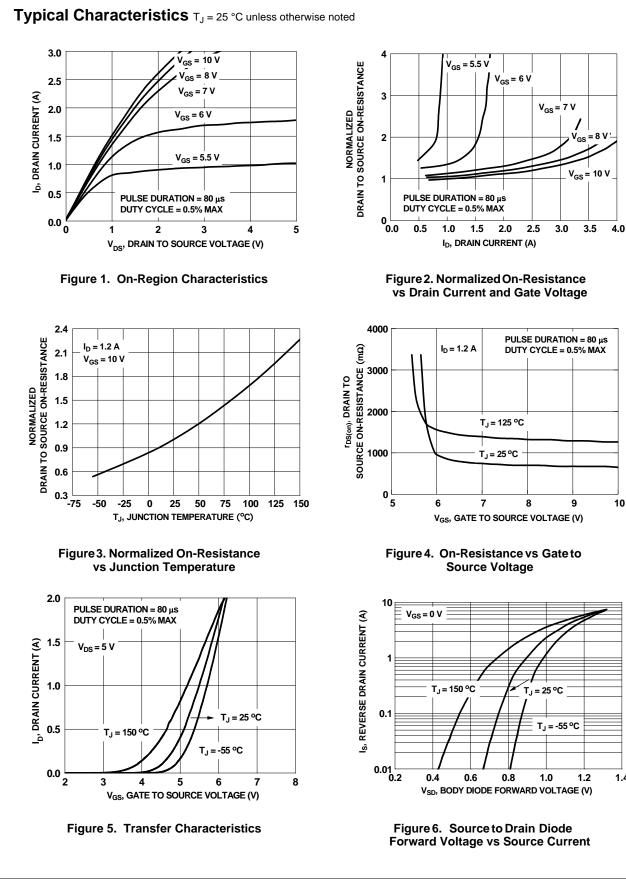


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b) 118 °C/W when mounted on a minimum pad of 2 oz copper

Pulse Test: Pulse Width < 300 μs, Duty cycle < 2.0 %.</li>
Starting T<sub>J</sub> = 25 °C, L = 3 mH, I<sub>AS</sub> = 1 A, V<sub>DD</sub> = 150 V, V<sub>GS</sub> = 10 V.
The diode connected between gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

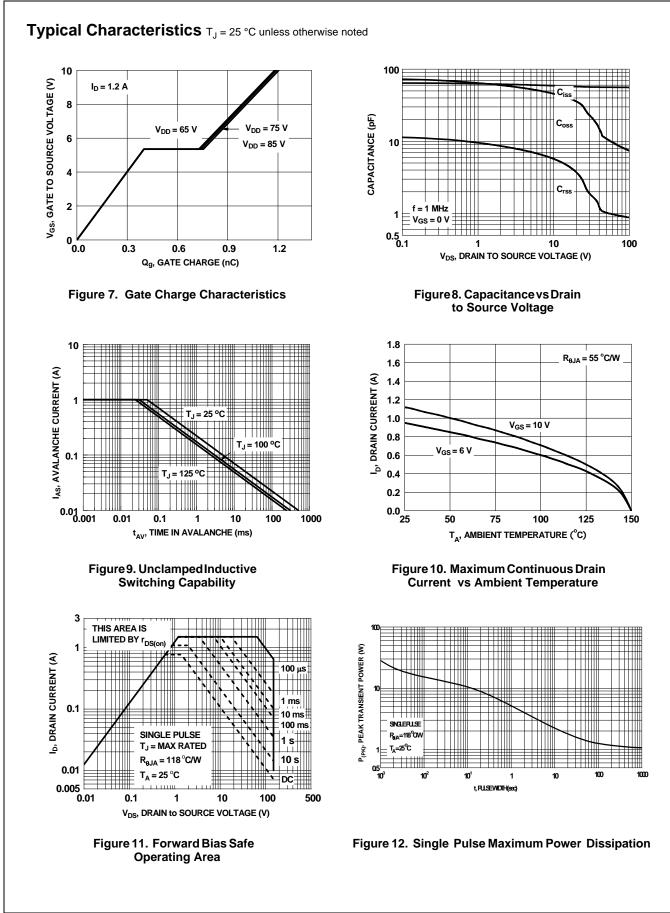
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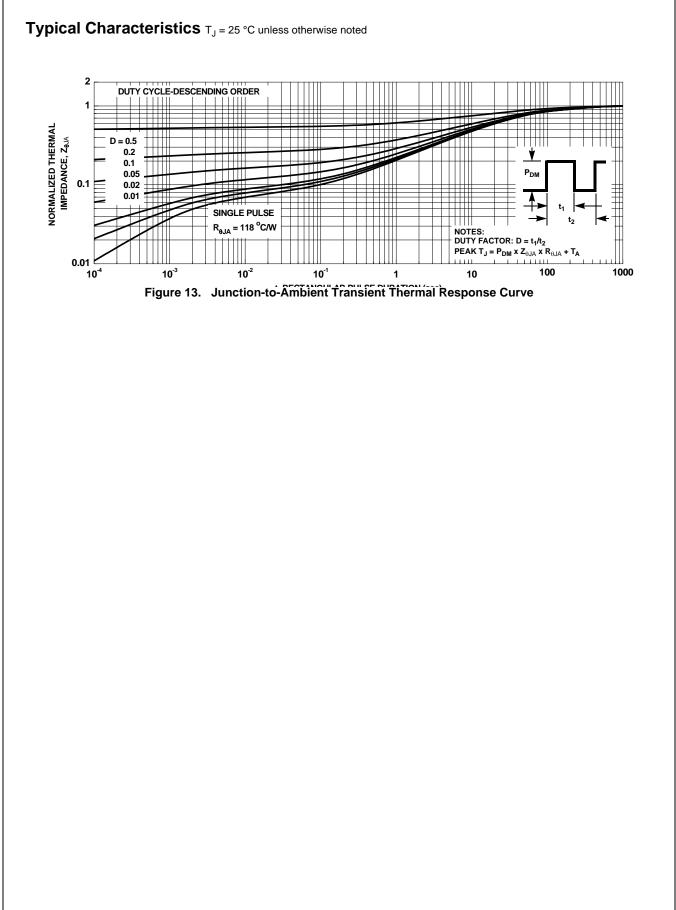
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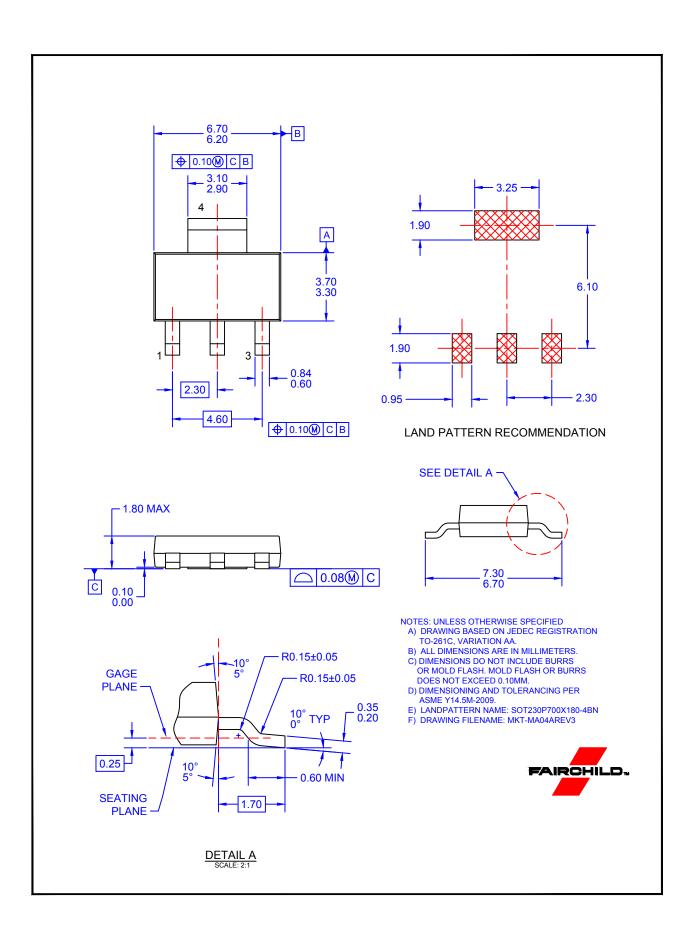
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